

STD5N65M6

N-channel 650 V, 1.15 Ω typ., 4 A MDmesh[™] M6 Power MOSFET in a DPAK package

Datasheet - production data



Order code	VDS	R _{DS(on)} max.	ID
STD5N65M6	650 V	1.3 Ω	4 A

- Reduced switching losses
- Lower R_{DS(on)} x area vs previous generation
- Low gate input resistance
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

The new MDmeshTM M6 technology incorporates the most recent advancements to the well-known and consolidated MDmesh family of SJ MOSFETs. STMicroelectronics builds on the previous generation of MDmesh devices through its new M6 technology, which combines excellent $R_{DS(on)}$ * area improvement with one of the most effective switching behaviors available, as well as a user-friendly experience for maximum endapplication efficiency.

Order code	Marking	Package	Packing
STD5N65M6	5N65M6	DPAK	Tape and reel

DocID029222 Rev 1

This is information on a product in full production.

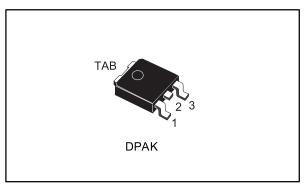
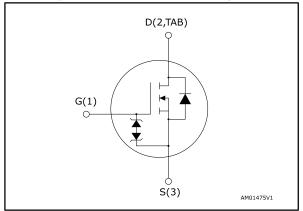


Figure 1: Internal schematic diagram



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1 Electrical ratings

 Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vgs	Gate-source voltage	± 25	V
ID	Drain current (continuous) at T _C = 25 °C	4	А
lD	Drain current (continuous) at Tc = 100 °C	2.5	А
IDM ⁽¹⁾	Drain current (pulsed)	16	А
P _{TOT}	Total dissipation at $T_C = 25 \ ^{\circ}C$	45	W
dv/dt ⁽²⁾	Peak diode recovery voltage slope	5	V/ns
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	50	v/ns
TJ	Operating junction temperature range		°C
T _{stg}	Storage temperature range	-55 to 150	C

Notes:

 $^{(1)}$ Pulse width limited by safe operating area $^{(2)}I_{SD} \leq 4$ A, di/dt = 400 A/µs; V_{DS peak} < V_{(BR)DSS}, V_{DD} = 400 V

 $^{(3)}V_{DS} \leq 520 \text{ V}$

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj} -case	Thermal resistance junction-case	2.78	9 C AN/
Rthj-pcb ⁽¹⁾	Thermal resistance junction-pcb	50	°C/W

Notes:

⁽¹⁾When mounted on FR-4 board of inch², 2oz Cu.

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by $T_{\mbox{\scriptsize jmax}}$)	1	Α
Eas	Single pulse avalanche energy (starting $T_j=25^{\circ}C$, $I_D=I_{AR}$, $V_{DD}=50$ V)	90	mJ



2 Electrical characteristics

 $T_C = 25$ °C unless otherwise specified

Table 5: On/off-state							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
V(BR)DSS	Drain-source breakdown voltage	V _{GS} = 0, I _D = 1 mA	650			V	
	V_{GS} = 0 V, V_{DS} = 650 V			1	μA		
I _{DSS}	I _{DSS} Zero gate voltage drain current	$V_{GS} = 0 V, V_{DS} = 650 V;$ $T_{C} = 125 \ ^{\circ}C \ ^{(1)}$			100	μA	
Igss	Gate body leakage current	$V_{DS} = 0 V, V_{GS} = \pm 25 V$			±5	μA	
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2.25	3	3.75	V	
R _{DS(on)}	Static drain-source on-resistance	$V_{GS}=10~V,~I_{D}=2~A$		1.15	1.3	Ω	

Table 5: On/off-state

Notes:

⁽¹⁾Defined by design, not subject to production test.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	170	-	pF
Coss	Output capacitance	- V _{DS} = 100 V, f = 1 MHz, V _{GS} = 0 V	-	20	-	pF
Crss	Reverse transfer capacitance		-	1	-	pF
C _{oss} eq. ⁽¹⁾	Equivalent output capacitance	$V_{DS} = 0$ to 520 V, $V_{GS} = 0$ V	-	35	-	pF
Rg	Intrinsic gate resistance	f = 1 MHz, I _D =0 A	-	5	-	Ω
Qg	Total gate charge	$V_{DD} = 350 \text{ V}, \text{ I}_D = 1 \text{ A}, \text{ V}_{GS} = 10 \text{ V},$ (see <i>Figure 15: "Test circuit for</i>	-	5.1	-	nC
Qgs	Gate-source charge		-	0.8	-	nC
Q_{gd}	Gate-drain charge	gate charge behavior")	-	2	-	nC

Table 6: Dynamic

Notes:

 $^{(1)}C_{oss\ eq.}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

Table	7:	Switching	times
- unit		omitoring	

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V_{DD} = 325 V, I_D = 2 A, R_G = 4.7 Ω ,	-	6.5	-	ns
tr	Rise time	V _{GS} = 10 V (see Figure 14: "Test circuit for resistive load switching	-	5.9	-	ns
t _{d(off)}	Turn-off delay time	times" and Figure 19: "Switching	-	17.4	-	ns
tf	Fall time	time waveform")	-	15.2	-	ns



Electrical characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Isd	Source-drain current		-		4	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		16	А
Vsd ⁽²⁾	Forward on voltage	$I_{SD} = 4 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$	-		1.6	V
trr	Reverse recovery time	I _{SD} = 4 A, di/dt = 100 A/µs,	-	222		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}$, (see <i>Figure 19</i> :	-	1.24		μC
IRRM	Reverse recovery current	"Switching time waveform")	-	11.2		Α
t _{rr}	Reverse recovery time	I _{SD} = 4 A, di/dt = 100 A/µs,	-	264		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{j} = 150 \text{ °C}$ (see Figure 19: "Switching	-	1.39		μC
IRRM	Reverse recovery current	time waveform")	-	10.5		Α

Notes:

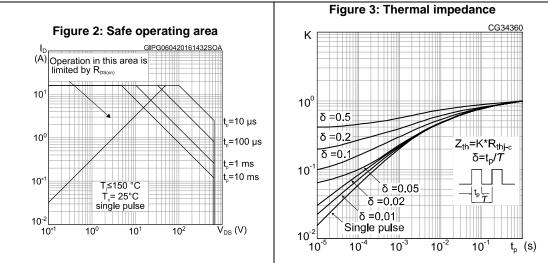
 $\ensuremath{^{(1)}}\ensuremath{\mathsf{Pulse}}$ width limited by safe operating area

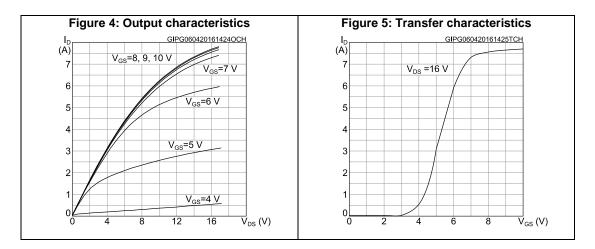
 $^{(2)}\text{Pulsed:}$ pulse duration = 300 $\mu\text{s},$ duty cycle 1.5%

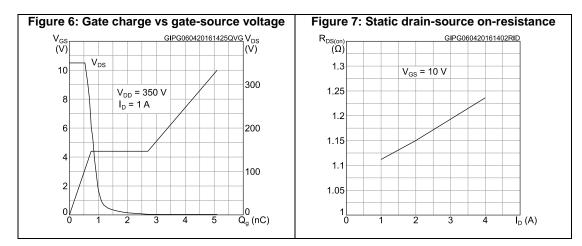




Electrical characteristics (curves)



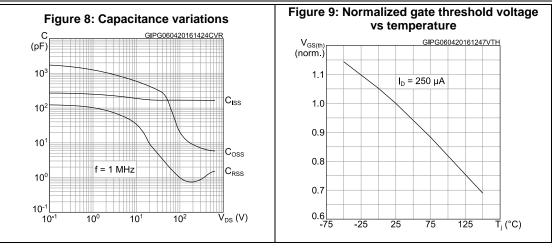


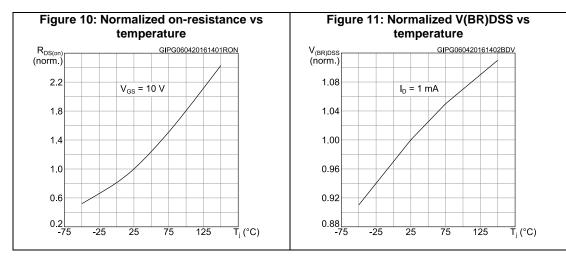


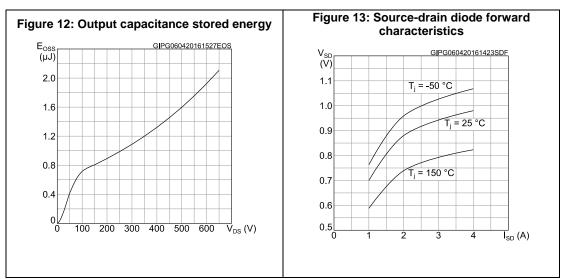


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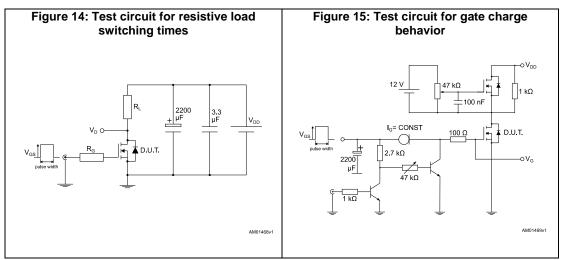
Electrical characteristics

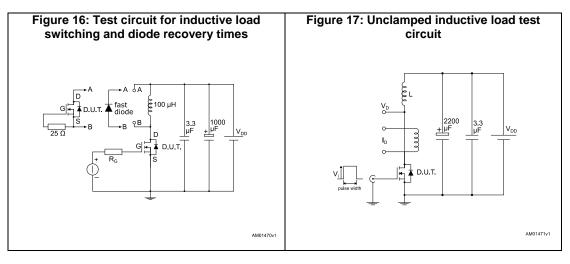


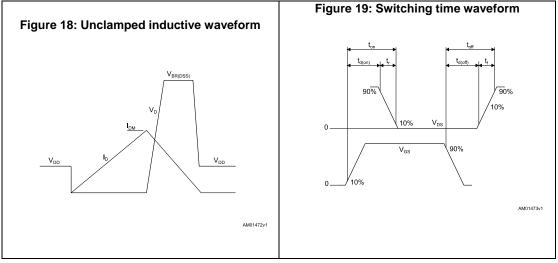




3 Test circuits







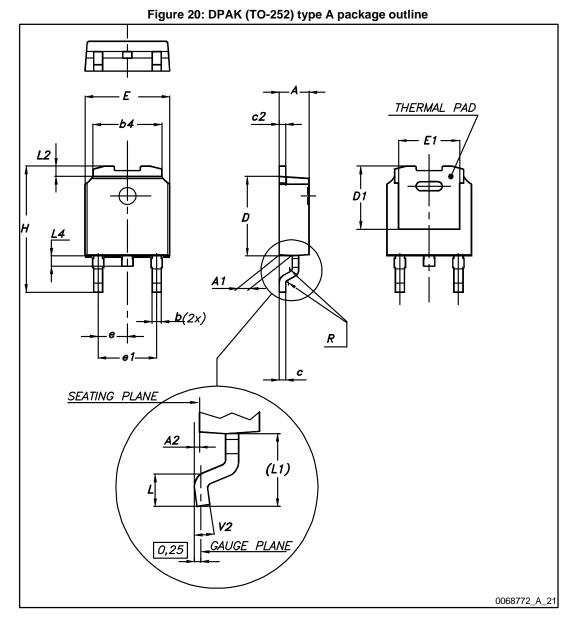


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4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 DPAK (TO-252) package information



Package information

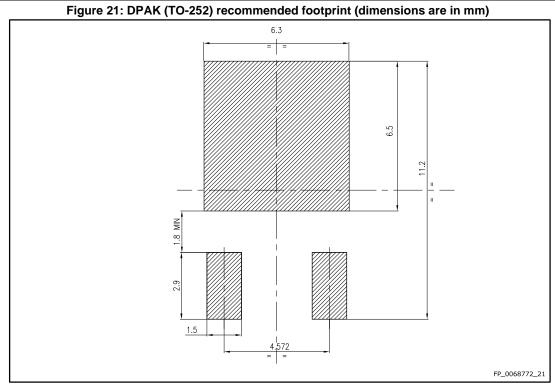
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Table 9: DPAK (TO-252) type A mechanical data						
Dim.	mm					
	Min.	Тур.	Max.			
A	2.20		2.40			
A1	0.90		1.10			
A2	0.03		0.23			
b	0.64		0.90			
b4	5.20		5.40			
с	0.45		0.60			
c2	0.48		0.60			
D	6.00		6.20			
D1	4.95	5.10	5.25			
E	6.40		6.60			
E1	4.60	4.70	4.80			
е	2.16	2.28	2.40			
e1	4.40		4.60			
Н	9.35		10.10			
L	1.00		1.50			
(L1)	2.60	2.80	3.00			
L2	0.65	0.80	0.95			
L4	0.60		1.00			
R		0.20				
V2	0°		8°			

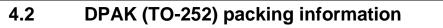


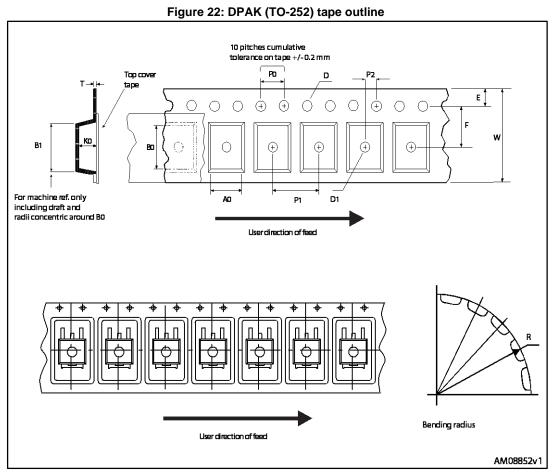
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Package information











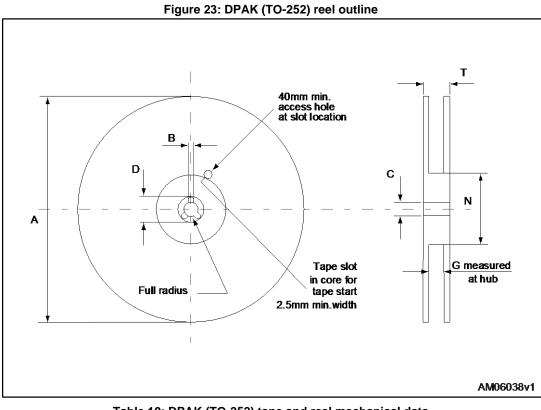


Table 10: DPAK (TO-252) tape and reel mechanical data							
Таре		Reel					
Dim.	mm		Dim	r	mm		
	Min.	Max.	Dim.	Min.	Max.		
A0	6.8	7	A		330		
B0	10.4	10.6	В	1.5			
B1		12.1	С	12.8	13.2		
D	1.5	1.6	D	20.2			
D1	1.5		G	16.4	18.4		
E	1.65	1.85	N	50			
F	7.4	7.6	Т		22.4		
K0	2.55	2.75					
P0	3.9	4.1	Base qty.		2500		
P1	7.9	8.1	Bulk qty. 2		2500		
P2	1.9	2.1					
R	40						
Т	0.25	0.35					
W	15.7	16.3					

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5 Revision history

Table 11: Document revision history

Date	Revision	Changes
05-May-2016	1	Initial release.



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